



NOTES:

- MATERIAL:
HOUSING: High Temperature Thermoplastic
Terminal:Copper Alloy
Shell: Stainless Steel
 - PLATING:
Terminal:50μ Ni UNDERPLATED OVERALL
G/F PLATED ON CONTACT AREA AND SOLDER AREA
Sheet:30μ Ni UNDERPLATED OVERALL
G/F PLATED ON CONTACT AREA AND SOLDER AREA
 - TECHNICAL SPECIALITY:
RATED VOLTAGE: 30V AC MAX.
CURRENT RATING: 0.5A MAX.
INSULATION RESISTANCE:1000MΩ MIN
CONTACT RESISTANCE:50mΩ MAX
WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTES
OPERATING TEMPERATURE: -40 ~+85 Humidity 80% R.H MAX
- 4.DIMENSIONS WITH MARK * "MUST BE MEASURE BY QC AND IPQC

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